**Material Set Change:**

|  |  |  |  |
| --- | --- | --- | --- |
|  | |  |  |
| Package Material Set | | Carsem | ASE Chungli |
| 8L, and 14L SOICN | Die Attach | Ablestik 84-1 LMISR4 | Hitachi EN4900 |
| Mold Compound | Sumitomo 6600H | Hitachi CEL9240HF10AK |
| Wire | 0.8mil, 1.0mil, 1.2 and 1.3 mil Gold wire | 0.8mil, 1.0mil, 1.2 and 1.3 mil Gold wire |